

Vishay Semiconductors

Phase Control Thyristors (Stud Version), 200 A



PRIMARY CHARACTERISTICS				
I _{T(AV)}	200 A			
V_{DRM}/V_{RRM}	400 V, 800 V, 1200 V			
V_{TM}	1.75 V			
I _{GT}	150 mA			
TJ	-40 °C to +125 °C			
Package	TO-93 (TO-209AB)			
Circuit configuration	Single SCR			

FEATURES

- · Center amplifying gate
- International standard case TO-93 (TO-209AB)
- RoHS
- Glass-metal seal up to 1200 V
- Compression bonded encapsulation for heavy duty operations such as severe thermal cycling
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
		200	A		
I _{T(AV)}	T _C	85	°C		
I _{T(RMS)}		314	A		
I _{TSM}	50 Hz	5000	^		
	60 Hz	5230	Α Α		
l ² t	50 Hz	125	kA ² s		
	60 Hz	114	KA ² S		
V _{DRM} /V _{RRM}		400 to 1200	V		
tq	Typical	100	μs		
T _J		-40 to +125	°C		

ELECTRICAL SPECIFICATIONS

VOLTAGE	VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE	" "					
		V	V	mA					
	04	400	500						
VS-ST180S	08	800	900	30					
	12	1200	1300						



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ABSOLUTE MAXIMUM RATINGS	S					
PARAMETER	SYMBOL		TEST CONDITIONS			UNITS
Maximum average on-state current	I _{T(AV)}	180° condu	ction, half sine	wave	200	Α
at case temperature	-1(AV)		,		85	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 76 °C	case temperat	ure	314	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle	ı	t = 8.3 ms	reapplied		5230	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4200	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	4400	
Maximum I ² t for fusing		t = 10 ms	No voltage reapplied	initial T _J = T _J maximum	125	
	l ² t	t = 8.3 ms			114	
		t = 10 ms	100 % V _{RRM}		88	
		t = 8.3 ms	reapplied		81	
Maximum I ² √t for fusing	I ² √t	t = 0.1 to 10	t = 0.1 to 10 ms, no voltage reapplied			kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	$I_{T(AV)}$), $T_J = T_J$ maximum	1.08	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.14	V
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ maximum		1.18	~ 0	
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.14	mΩ	
Maximum on-state voltage	V_{TM}	$I_{pk} = 570 \text{ A}, T_J = 125 ^{\circ}\text{C}, t_p = 10 \text{ ms sine pulse}$		1.75	V	
Maximum holding current	I _H	T T	.inama anad	unnly 10 \/ vaniative la = -!	600	A
Maximum (typical) latching current	ΙL	$T_J = T_J$ maximum, anode supply 12 V resistive load 1000 (3		1000 (300)	mA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/µs
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	1.0	
Typical turn-off time	tq	$I_{TM} = 300 \text{ A, } T_J = T_J \text{ maximum, dl/dt} = 20 \text{ A/}\mu\text{s,}$ $V_R = 50 \text{ V, dV/dt} = 20 \text{ V/}\mu\text{s, gate } 0 \text{ V } 100 \Omega\text{, } t_p = 500 \mu\text{s}$	100	μs

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	T _J = T _J maximum linear to 80 % rated V _{DRM}	500	V/µs
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA



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TRIGGERING						
PARAMETER	SYMBOL	_	TEST COMPLETIONS		VALUES	
PARAMETER	STIVIBUL	TEST CONDITIONS		TYP.	MAX.	UNITS
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	1	0	W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	VV
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	3	.0	Α
Maximum peak positive gate voltage	+V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms		$tm, t_p \le 5 \text{ ms}$ 5.0		V
Maximum peak negative gate voltage	-V _{GM}					
DC gate current required to trigger	I _{GT}	T _J = - 40 °C	Maximum required gate trigger / current / voltage are the lowest value which will trigger all units 12 V anode to cathode applied	180	-	
		T _J = 25 °C		90	150	mA
		T _J = 125 °C		40	-	
	V _{GT}	T _J = - 40 °C		2.9	-	
DC gate voltage required to trigger		T _J = 25 °C		1.8	3.0	V
		T _J = 125 °C		1.2	-	
DC gate current not to trigger	I _{GD}		Maximum gate current/voltage not			mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J$ maximum to trigger is the maxin which will not trigger an rated V_{DRM} anode to applied		0.05		V

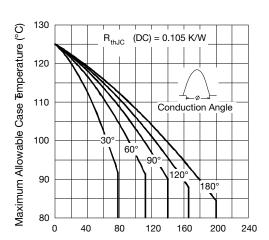
THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ		-40 to +125	°C	
Maximum storage temperature range	T _{Stg}		-40 to +150		
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.105	K/W	
Maximum thermal resistance, case to heatsink	R _{thC-hs}	-hs Mounting surface, smooth, flat and greased		IV VV	
Mounting toward 100/		Non-lubricated threads	31 (275)	N · m	
Mounting torque, ± 10 %		Lubricated threads	24.5 (210)	(lbf · in)	
Approximate weight			280	g	
Case style		See dimensions - link at the end of datasheeet TO-93 (TO-209AE		09AB)	

ΔR_{thJC} CONDUCTION				
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS
180°	0.015	0.012		
120°	0.019	0.020		
90°	0.025	0.027	$T_J = T_J$ maximum	K/W
60°	0.036	0.037		
30°	0.060	0.060		

Note

[•] The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

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Fig. 1 - Current Ratings Characteristics

Average On-state Current (A)

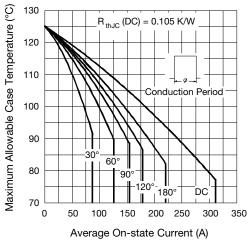


Fig. 2 - Current Ratings Characteristics

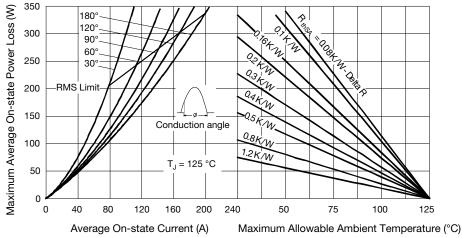


Fig. 3 - On-State Power Loss Characteristics

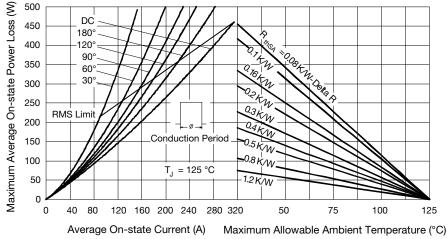


Fig. 4 - On-State Power Loss Characteristics

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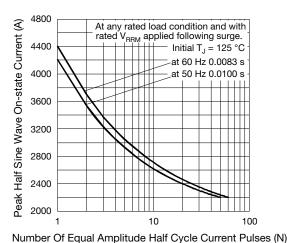


Fig. 5 - Maximum Non-Repetitive Surge Current

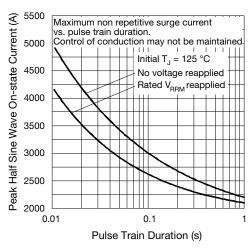


Fig. 6 - Maximum Non-Repetitive Surge Current

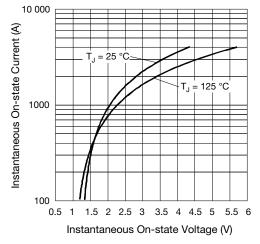


Fig. 7 - On-State Voltage Drop Characteristics

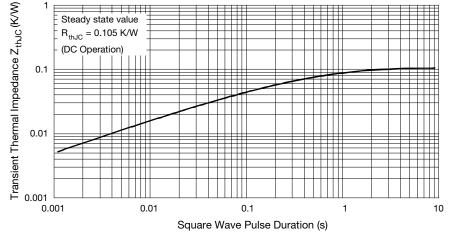


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

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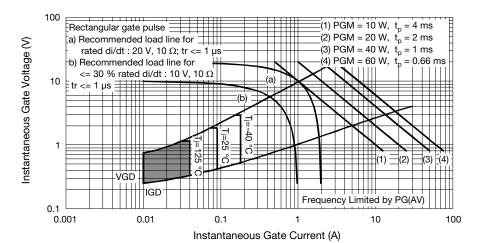
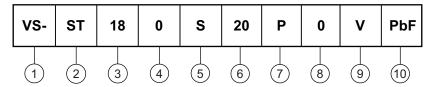


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE

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Device code



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2 - Thyristor

3 - Essential part number

4 - 0 = converter grade

5 - S = compression bonding stud

6 - Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

P = stud base 3/4"-16UNF2A threads

8 - 0 = eyelet terminals (gate and auxiliary cathode leads)

1 = fast-on terminals (gate and auxiliary cathode leads)

9 - V = glass-metal seal (only up to 1200 V)

10 - None = standard production

PbF = lead (Pb)-free

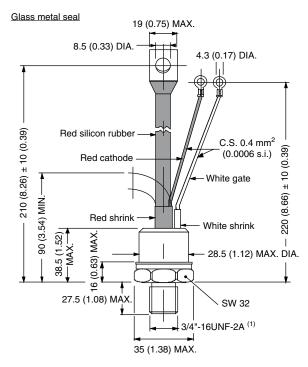
LINKS TO RELAT	TED DOCUMENTS
Dimensions	www.vishay.com/doc?95082

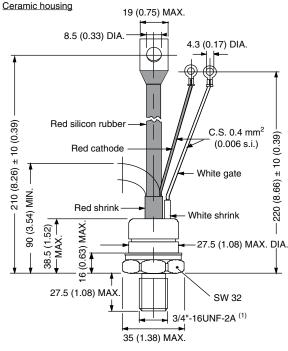


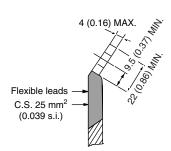
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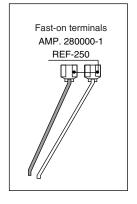
TO-209AB (TO-93)

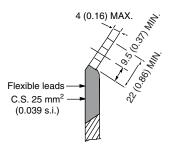
DIMENSIONS in millimeters (inches)











Note

(1) For metric device: M16 x 1.5 - length 21 (0.83) maximum



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